

SOT-363 Plastic-Encapsulate MOSFETS

CJ3139KDW Dual P-Channel Power MOSFET

GENERAL DESCRIPTION

This Dual P-Channel MOSFET has been designed using advanced Power Trench process to optimize the $R_{DS(ON)}$.

Including two P-ch CJ3139K MOSFET (independently) in a package.

FEATURE

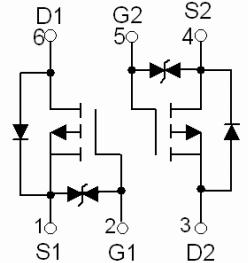
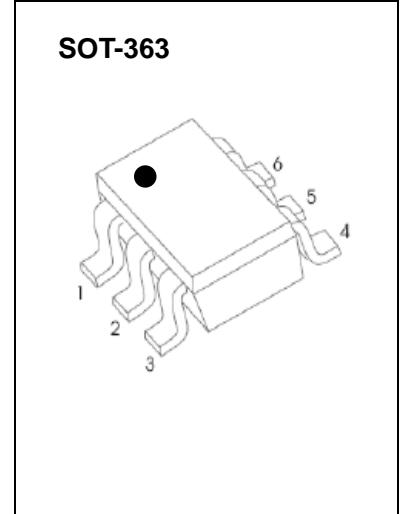
- High-Side Switching
- Low On-Resistance
- Low Threshold
- Fast Switching Speed

APPLICATION

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

MARKING: 39K

Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)



Parameter	Symbol	Value	Units
Drain-Source voltage	V_{DSS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	
Drain Current-Continuous	$I_{D(DC)}$	-0.66	A
Drain Current -Pulsed(note1)	$I_{DM(\text{pulse})}$	-2.64	
Power Dissipation (note 2)	P_D	150	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	°C/W
Storage Temperature	T_j	150	°C
Junction Temperature	T_{stg}	-55 ~+150	

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
On/Off States						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Gate-Threshold Voltage(note 3)	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.35		-1.1	
Gate-Body Leakage Current	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 12\text{V}$			± 20	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Drain-Source On-State Resistance(note 3)	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}$			520	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -800\text{mA}$			700	
		$V_{\text{GS}} = -1.8\text{V}, I_D = -500\text{mA}$			950	
Forward Transconductance	g_{fs}	$V_{\text{DS}} = -10\text{V}, I_D = -540\text{mA}$	0.8			S
Dynamic Characteristics(note 4)						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -16\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$			170	pF
Output Capacitance	C_{oss}				25	
Reverse Transfer Capacitance	C_{rss}				15	
Switching Times (note 4)						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, I_D = -200\text{mA}, V_{\text{GS}} = -4.5\text{V}, R_G = 10\Omega$		9		ns
Rise Time	t_r			5.8		
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			32.7		
Fall Time	t_f			20.3		
Drain-Source Diode Characteristics						
Drain-Source Diode Forward Voltage (note 3)	V_{SD}	$I_S = -0.5\text{A}, V_{\text{GS}} = 0\text{V}$			-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at $T_a=25^\circ\text{C}$.
3. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.
4. These parameters have no way to verify.